

UNISONIC TECHNOLOGIES CO., LTD

5NM50A **Preliminary** Power MOSFET

5.0A, 500V N-CHANNEL SUPER-JUNCTION MOSFET

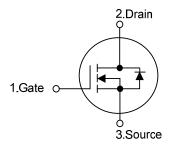
DESCRIPTION

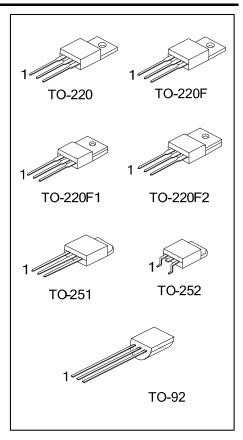
The UTC 5NM50A is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

FEATURES

- * $R_{DS(ON)}$ < 1.08 Ω @ V_{GS} = 10 V, I_D = 2.5 A
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness

SYMBOL



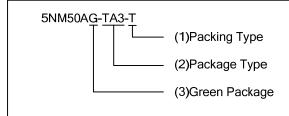


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■ ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
5NM50AL-TA3-T	5NM50AG-TA3-T	TO-220	G	D	S	Tube	
5NM50AL-TF1-T	5NM50AG-TF1-T	TO-220F1	G	D	S	Tube	
5NM50AL-TF2-T	5NM50AG-TF2-T	TO-220F2	G	D	S	Tube	
5NM50AL-TF3-T	5NM50AG-TF3-T	TO-220F	G	D	S	Tube	
5NM50AL-TM3-T	5NM50AG-TM3-T	TO-251	G	D	S	Tube	
5NM50AL-TN3-R	5NM50AG-TN3-R	TO-252	G	D	S	Tape Reel	
5NM50AL-T92-B	5NM50AG-T92-B	TO-92	G	D	S	Tape Box	
5NM50AL-T92-K	5NM50AG-T92-K	TO-92	G	D	S	Bulk	

Note: Pin Assignment: G: Gate D: Drain S: Source

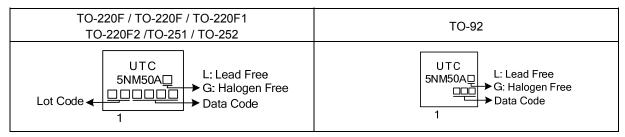


- (1) T: Tube, R: Tape Reel
- (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TM3: TO-251, TN3: TO-252

T92: TO-92

(3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING





■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	500	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous	I_{D}	5	Α
	Pulsed (Note 2)	I_{DM}	20	Α
Avalanche Current (Note 2)		I _{AR}	1.55	Α
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	97.3	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.0	V/ns
Power Dissipation	TO-220		78	W
	TO-220F/TO-220F1		36	W
	TO-220F2	P_{D}	29	W
	TO-251/TO-252		54	W
	TO-92		1.78	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating : Pulse width limited by maximum junction temperature.
- 3. L = 81mH, I_{AS} = 1.55A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 5.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2	0	62.5	°C/W
	TO-251/TO-252	θ_{JA}	110	°C/W
	TO-92		160	°C/W
Junction to Case	TO-220		1.6	°C/W
	TO-220F/TO-220F1		3.47	°C/W
	TO-220F2	θ_{JC}	4.3	°C/W
	TO-251/TO-252		2.3	°C/W
	TO-92		70	°C/W



ELECTRICAL CHARACTERISTICS (Ty=25°C, unless otherwise specified)

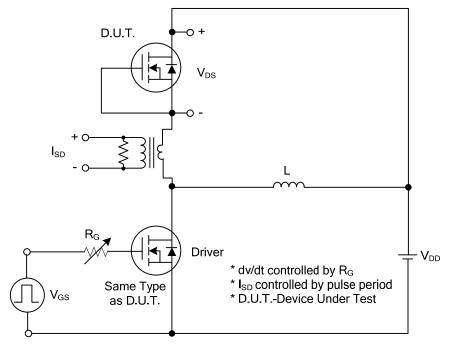
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS					•	•		
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	500			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V			10	μΑ	
Gate-Source Leakage Current	Forward		$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA	
	Reverse	I_{GSS}	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} = 10 V, I _D = 2.5 A			1.08	Ω	
DYNAMIC CHARACTERISTICS	_				-			
nput Capacitance		C_{ISS}			300		pF	
Output Capacitance		C_{oss}	V_{GS} =0V, V_{DS} =25V, f=1MHz		175		pF	
Reverse Transfer Capacitance		C_{RSS}			25		pF	
SWITCHING CHARACTERISTIC								
Total Gate Charge (Note 1)		Q_G	V _{DS} =50V, V _{GS} =10V, I _D =1.3A,		30		nC	
Gate to Source Charge		Q_GS	$V_{DS}=50V$, $V_{GS}=10V$, $I_{D}=1.5A$, $I_{D}=100\mu A$ (Note 1, 2)		4		nC	
Gate to Drain Charge		Q_GD	10-100μΑ (1000 1, 2)		11		nC	
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$			40		ns	
Rise Time		t_{R}	V_{DS} =30V, V_{GS} =10V, I_{D} =0.5A,		72		ns	
Turn-OFF Delay Time		$t_{D(OFF)}$	R _G =25Ω (Note 1, 2)		107		ns	
Fall-Time		t_{F}			46		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current		Is				5	Α	
Maximum Body-Diode Pulsed Current		I _{SM}				20	Α	
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =5.0A , V _{GS} =0V			1.4	V	
Body Diode Reverse Recovery Time (Note 1)		t _{rr}	I _S =5.0A , V _{GS} =0V dI _F /dt=100A/µs		230		ns	
Body Diode Reverse Recovery Charge		Q_{rr}			1.9		μC	

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

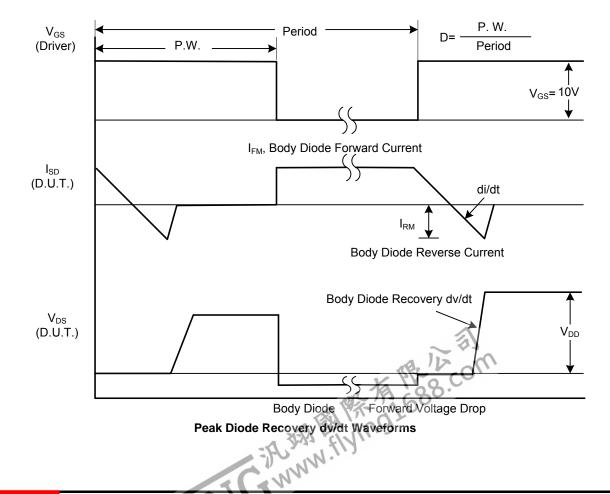


^{2.} Essentially independent of operating temperature.

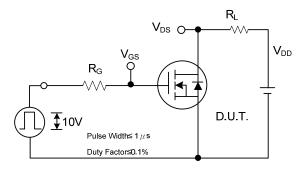
TEST CIRCUITS AND WAVEFORMS



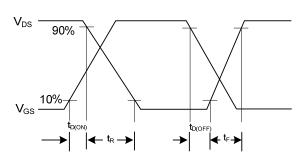
Peak Diode Recovery dv/dt Test Circuit



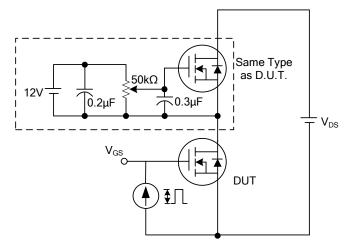
TEST CIRCUITS AND WAVEFORMS (Cont.)



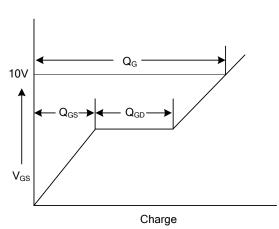
Switching Test Circuit



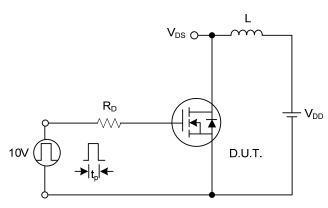
Switching Waveforms



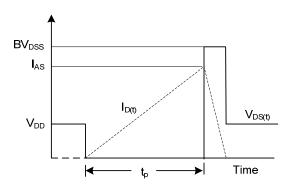
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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